Abstracts

0.4-8 GHz broadband MMICs in novel RF chip size package for optical video distribution system

K. Fujimoto, K. Kawashima, M. Nishitsuji, K. Nobori, H. Nagata and O. Ishikawa. "0.4-8 GHz broadband MMICs in novel RF chip size package for optical video distribution system." 2000 Radio Frequency Integrated Circuits (RFIC) Symposium 00. (2000 [RFIC]): 161-164.

0.4-8 GHz broadband MMICs in the novel RF chip size package (RF-CSP) have been developed for the optical video distribution system. By using anisotropic conductive film (ACF) for the flip-chip bonding, fabrication process of RF-CSP becomes very simple and cost effective. This RF-CSP is one of the smallest packages ever reported.

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